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To the Director of the U.S. Patent and Trademark Office: Plea	se record the attached documents or the new address(es) below.
I. Name of conveying party(ies)/Execution Date(s):	2. Name and address of receiving party(ies)
Tae-Hyun KIM	Name: Samsung Electronics Co., Ltd
	Internal Address:
Execution Date(s) 02-14-2005	Street Address: <u>416 Maetan-dong, Yeongtong-gu</u>
3. Nature of conveyance: ✓ Assignment  Merger	City: Suwon-si, Gyeonggi-do
Security Agreement Change of Name	State:
Government Interest Assignment Executive Order 9424, Confirmatory License	Country: <u>Republic of Korea</u> Zip:
Other	Additional name(s) & address(es) attached? Yes Vo
<ul> <li>Application or patent number(s):</li> <li>A. Patent Application No.(s)</li> </ul>	document is being filed together with a new application. B. Patent No.(s)
Additional numbers a	ttached? Yes No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name:Roylance, Abrams, Berdo & Goodman, L.L.P.	7. Total fee (37 CFR 1.21(h) & 3.41) \$_40.00
Internal Address:	Authorized to be charged by credit card
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9. Signature: Signature	O2-24-2005 Date Total number of pages including cover sheet, attachments, and documents: 3 et) should be faxed to (703) 306-5995, or mailed to: of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450
Garrett V. Davis	Total number of pages including cover 3 sheet, attachments, and documents:
Name of Person Signing	

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03-08-2005

PATENT REEL: 016324 FRAME: 0857

## ASSIGNMENT

WHEREAS, I, Tae-hyun Kim, a citizen of the Republic of Korea, residing at 201-1412 Seongil Apt., 810-4 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter ASSIGNOR), have made a certain invention entitled **DEVELOPING ROLLER FOR ELECTROGRAPHIC APPARATUS AND ELECTROGRAPHIC APPARATUS CONTAINING THE SAME** for which I am making application for Letters Patent of the United States, said application being executed concurrently herewith; and

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all United States Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to me by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, by these presents do hereby sell, assign, set over and transfer unto said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in the United States; and my right to file said applications and claim priority under the provisions of any international convention or treaty; and any Letters Patent of the United States issued or granted on said invention and/or said applications;

AND I HEREBY authorize and request the U.S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said application to said ASSIGNEE as sole assignee;

AND I HEREBY covenant that I have the full right to convey the entire right, title and interest herein assigned and that I have not executed and will not execute any assignment or other instrument in conflict herewith;

AND I HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in the United States, and

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likewise I make these provisions binding upon my heirs, legal representatives and/or administrators.

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IN WITNESS WHEREOF, I have hereunder set my hand and seal this <u>14th</u> <u>February</u>, 2005. day of

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TAE-HYVN 15/14 Tae-hyun Kim

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**RECORDED: 02/24/2005**